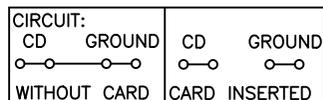


开关插卡状态



NOTES:

- MATERIAL:
 - Housing: High Temperature Thermoplastic UL94V-0; Color Black.
 - Terminal: Copper Alloy.
 - Shell: Stainless Steel.
- PLATING:
 - Contact: Contact Area: Au G/F, Solder area: Matte tin 80u"Min ; Under plate Ni 40u"Min all over
 - SHELL: Solder Area: Au G/F, Under plate Ni 50u"Min all over
 - CD PIN: Contact Area: Au G/F, Under plate Ni 50u"Min all over
- SPECIALITY:
 - Rated current: 1.0A
 - Rated voltage: 30V
 - Contact Resistance: 50mΩ MAX
 - Insulation Resistance: 1000MΩ MIN 500V DC
 - Dielectric withstanding voltage: 500V AC.
 - Solder ability: 255±5°C, 5±0.5s.
 - Durability: 10000 Cycles Min.
 - Operating condition: Temperature -40°C~+85°C; Humidity 80% R.H MAX

Pin No.	MICRO SD
PIN1	DAT2 1P
PIN2	CD/DAT3 2P
PIN3	CMD 3P
PIN4	VDD 4P
PIN5	CLK 5P
PIN6	VSS 6P
PIN7	DAT0 7P
PIN8	DAT1 8P
PIN9	CARD DETECT
PIN10	

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深圳市步步精科技有限公司

NAME: 卡座 TF CARD PUSH PUSH H=1.85 常闭一体式 贴片 无柱

APPD. JM_Zheng

CHKD. TSP

DR. LYX

PJ. NO.: CD.01.02-13-0004

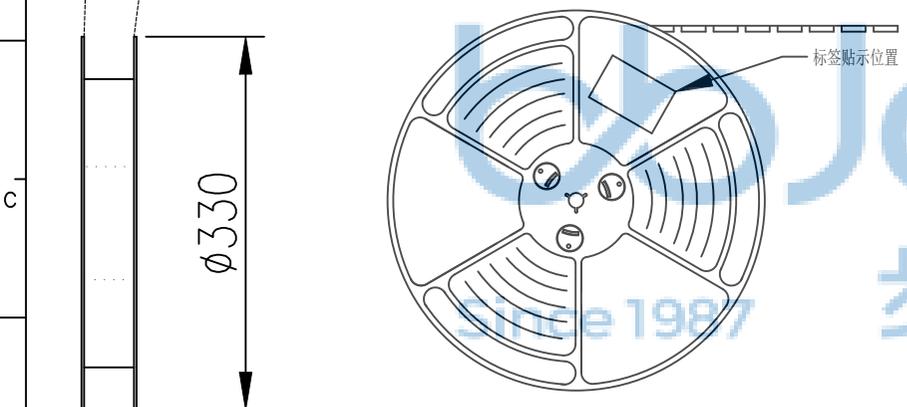
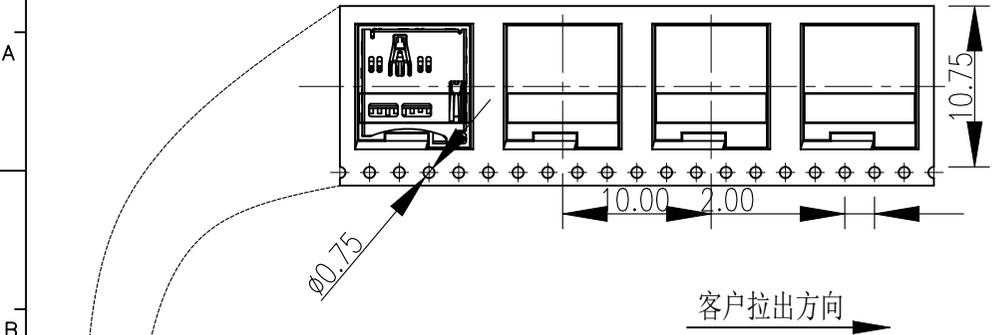
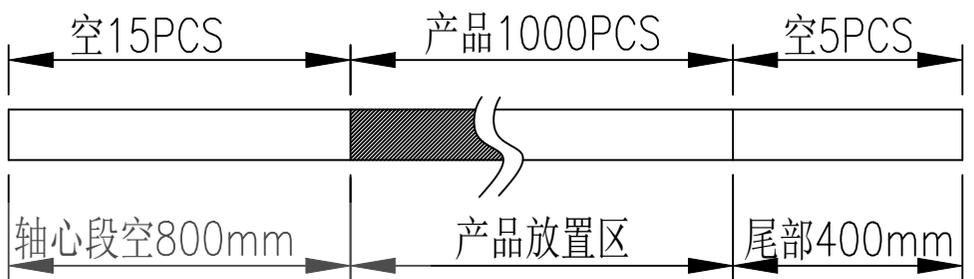
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FINISH: SEE NOTES MAT'L.: SEE NOTES

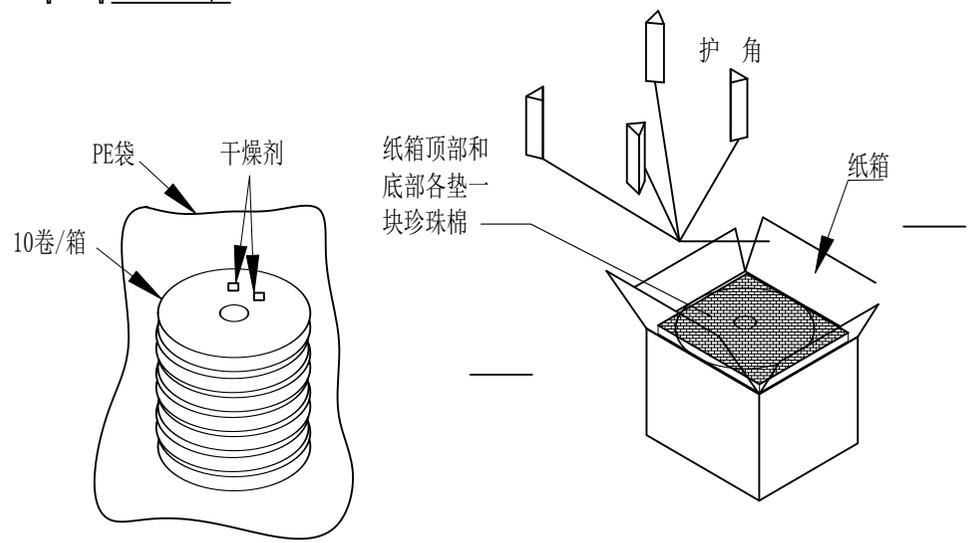
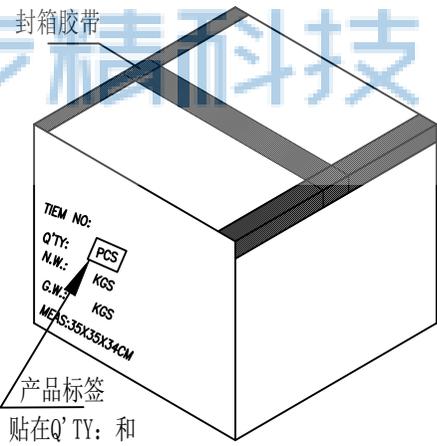
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NOTES

1. 每卷包装数量:1000PCS/每卷
2. 卷带包装方式:



3. 每箱包装数量:10000PCS/箱



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PDWG.NO: 0302-1	.X: ±0.38 .XX: ±0.25 .XXX: ±0.13	X*: ±3" .X*: ±2" .XX*: ±1"	